## 1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in Trench MOSFET technology and NPN Resistor-Equipped Transistor (RET) together in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Trench MOSFET technology
- NPN transistor built-in bias resistors
- Small and leadless ultra thin SMD plastic package: 2 x 2 x 0.65 mm
- Exposed drain pad for excellent thermal conduction

## 3. Applications

- Charging switch for portable devices
- High-side load switch
- USB port overvoltage protection
- Power management in battery-driven portables
- Hard disk and computing power management

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
P-channel Trei	P-channel Trench MOSFET								
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> = 25 °C		-	-	-30	V		
$V_{GS}$	gate-source voltage			-12	-	12	V		
I <sub>D</sub>	drain current	$V_{GS} = -4.5 \text{ V}; T_{amb} = 25 \text{ °C}; t \le 5 \text{ s}$	[1]	-	-	-3.4	Α		
P-channel Trei	P-channel Trench MOSFET; static characteristics								
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS}$ = -4.5 V; $I_D$ = -2.6 A; $T_j$ = 25 °C		-	85	110	mΩ		
NPN RET									
V <sub>CEO</sub>	collector-emitter voltage	T <sub>amb</sub> = 25 °C; open base		-	-	50	V		
Io	output current			-	-	100	mA		



#### 30 V P-channel MOSFET with pre-biased NPN transistor

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
NPN RET						
R1	bias resistor 1		3.3	4.7	6.1	kΩ
R2	bias resistor 2		-	47	-	kΩ

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>

# 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	6 5 4	C G S
2	В	base	7 8 R2 R1	
3	D	drain		
4	S	source		R2 R1
5	G	gate		
6	С	collector	Transparent top view  DFN2020-6 (SOT1118)	E B D 017aaa396
7	С	collector	DI 112020-0 (0011110)	017.aaa390
8	D	drain		

# 6. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
PMC85XP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body 2 x 2 x 0.65 mm	SOT1118				

# 7. Marking

Table 4. Marking codes

Type number	Marking code
PMC85XP	1K

#### 30 V P-channel MOSFET with pre-biased NPN transistor

# 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
P-channel	Trench MOSFET					
$V_{DS}$	drain-source voltage	T <sub>j</sub> = 25 °C		-	-30	V
$V_{GS}$	gate-source voltage			-12	12	V
I <sub>D</sub>	drain current	$V_{GS} = -4.5 \text{ V}; T_{amb} = 25 \text{ °C}; t \le 5 \text{ s}$	[1]	-	-3.4	Α
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 25 °C	[1]	-	-2.6	Α
		V <sub>GS</sub> = -4.5 V; T <sub>amb</sub> = 100 °C	[1]	-	-1.6	Α
I <sub>DM</sub>	peak drain current	$T_{amb}$ = 25 °C; single pulse; $t_p \le 10$ μs		-	-8	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	485	mW
			[1]	-	1170	mW
		T <sub>sp</sub> = 25 °C	[2]	-	8300	mW
P-channel	Trench MOSFET; source-drain	diode				
I <sub>S</sub>	source current	T <sub>amb</sub> = 25 °C	[1]	-	-1.2	Α
NPN RET						
$V_{CBO}$	collector-base voltage	T <sub>amb</sub> = 25 °C; open emitter		-	50	V
$V_{CEO}$	collector-emitter voltage	T <sub>amb</sub> = 25 °C; open base		-	50	V
V <sub>EBO</sub>	emitter-base voltage	T <sub>amb</sub> = 25 °C; open collector		-	10	V
VI	input voltage	positive		-	30	V
		negative		-	-5	V
$I_{O}$	output current			-	100	mA
I <sub>CM</sub>	peak collector current			-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = 25 °C	[2]	-	465	mW
			[1]	-	985	mW
		T <sub>sp</sub> = 25 °C	<u>[2]</u>	-	4160	mW
Per device	}					
$T_j$	junction temperature			-55	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>

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<sup>[2]</sup> Device mounted on an FR4 PCB, single-sided copper; tin-plated and standard footprint.

#### 30 V P-channel MOSFET with pre-biased NPN transistor

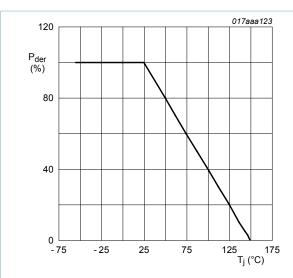


Fig. 1. Normalized total power dissipation as a function of junction temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$$

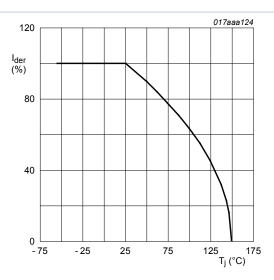


Fig. 2. Normalized continuous drain current as a function of junction temperature

$$I_{der} = \frac{I_D}{I_{D(25^{\circ}C)}} \times 100 \%$$

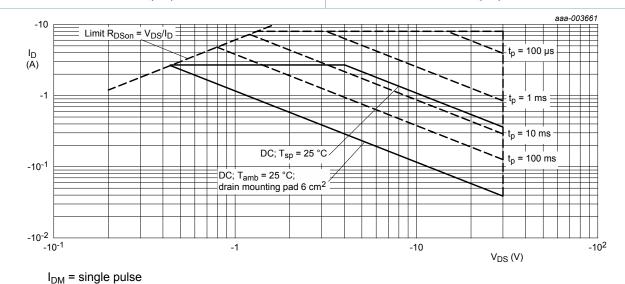


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

### 9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
P-channel 1	P-channel Trench MOSFET						
R <sub>th(j-a)</sub> thermal resistance from junction to ambient	thermal resistance	in free air	[1]	-	223	256	K/W
		[2]	-	93	107	K/W	
	ambient	t ≤ 5 s; in free air	[2]	-	55	63	K/W
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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	10	15	K/W
NPN RET	NPN RET						
R <sub>th(j-a)</sub> thermal resistance from junction to ambient		in free air	[1]	-	233	270	K/W
		[2]	-	110	127	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	25	30	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>

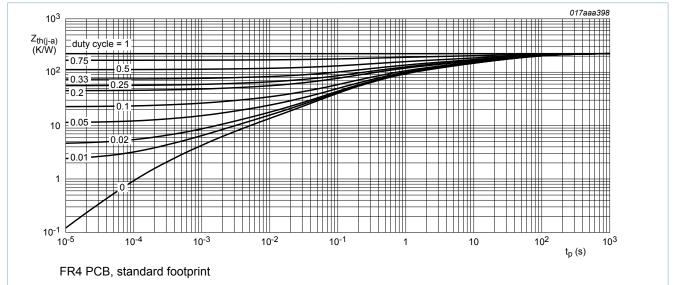


Fig. 4. P-channel Trench MOSFET: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

#### 30 V P-channel MOSFET with pre-biased NPN transistor

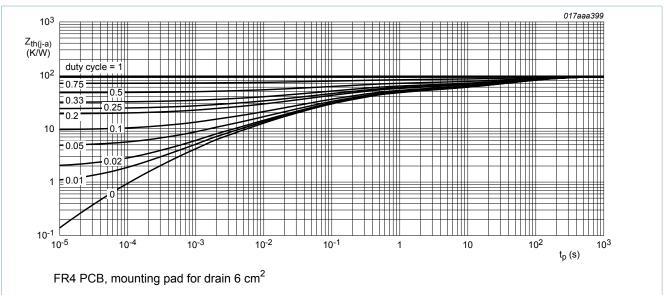


Fig. 5. P-channel Trench MOSFET: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

#### 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
P-channel 1	P-channel Trench MOSFET; static characteristics								
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = -250 \mu A; V_{GS} = 0 V; T_j = 25 °C$	-30	-	-	V			
$V_{GSth}$	gate-source threshold voltage	$I_D$ = -250 mA; $V_{DS}$ = $V_{GS}$ ; $T_j$ = 25 °C	-0.45	-0.78	-1	V			
I <sub>DSS</sub>	drain leakage current	V <sub>DS</sub> = -30 V; V <sub>GS</sub> = 0 V; T <sub>amb</sub> = 25 °C	-	-	-1	μA			
		V <sub>DS</sub> = -30 V; V <sub>GS</sub> = 0 V; T <sub>amb</sub> = 150 °C	-	-	-11	μA			
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA			
		V <sub>GS</sub> = -12 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C	-	-	100	nA			
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = -4.5 V; $I_D$ = -2.6 A; $T_j$ = 25 °C	-	85	110	mΩ			
	resistance	$V_{GS}$ = -4.5 V; $I_D$ = -2.6 A; $T_j$ = 150 °C	-	133	173	mΩ			
		$V_{GS}$ = -2.5 V; $I_D$ = -1.5 A; $T_j$ = 25 °C	-	105	140	mΩ			
9 <sub>fs</sub>	transfer conductance	$V_{DS}$ = -10 V; $I_D$ = -2.6 A; $T_j$ = 25 °C	-	10	-	S			
P-channel 1	Trench MOSFET; dynamic	characteristics			1				
Q <sub>G(tot)</sub>	total gate charge	$V_{DS}$ = -15 V; $I_D$ = -2.6 A; $V_{GS}$ = -4.5 V;	-	5.2	7.8	nC			
$Q_{GS}$	gate-source charge	T <sub>j</sub> = 25 °C	-	1.1	-	nC			
$Q_{GD}$	gate-drain charge		-	0.95	-	nC			
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = -15 V; f = 1 MHz; V <sub>GS</sub> = 0 V;	-	680	-	pF			
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C	-	54	-	pF			
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C <sub>rss</sub>	reverse transfer capacitance		-	40	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = -15 V; $I_{D}$ = -2.6 A; $R_{G(ext)}$ = 6 $\Omega$ ;	-	3	-	ns
t <sub>r</sub>	rise time	$V_{GS} = -4.5 \text{ V}; T_j = 25 \text{ °C}$	-	15	-	ns
t <sub>d(off)</sub>	turn-off delay time	_	-	112	-	ns
t <sub>f</sub>	fall time		-	48	-	ns
P-channel	Trench MOSFET; source-di	rain diode				
$V_{SD}$	source-drain voltage	$I_S$ = -1.2 A; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-0.8	-1.2	V
NPN RET		1				
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}; T_j = 25 ^{\circ}\text{C}$	-	-	100	nA
I <sub>CEO</sub>	collector-emitter cut-off	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 25 °C	-	-	1	μA
	current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}; T_{j} = 25 ^{\circ}\text{C}$	-	-	170	μA
h <sub>FE</sub>	DC current gain	$V_{CE}$ = 5 V; $I_{C}$ = 10 mA; $T_{j}$ = 25 °C	100	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C$ = 5 mA; $I_B$ = 0.25 mA; $T_j$ = 25 °C	-	-	100	mV
V <sub>I(off)</sub>	off-state input voltage	I <sub>C</sub> = 100 μA; V <sub>CE</sub> = 5 V; T <sub>j</sub> = 25 °C	-	0.6	0.5	V
V <sub>I(on)</sub>	on-state input voltage	$I_C = 5 \text{ mA}; V_{CE} = 0.3 \text{ V}; T_j = 25 ^{\circ}\text{C}$	1.3	0.9	-	V
R1	bias resistor 1		3.3	4.7	6.1	kΩ
R2	bias resistor 2		-	47	-	kΩ
R2/R1	bias resistor ratio		8	10	12	
C <sub>C</sub>	collector capacitance	$I_E = 0 \text{ A}; i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_j = 25 °C;$ $V_{CB} = 10 \text{ V}$	-	-	2.5	pF

#### 30 V P-channel MOSFET with pre-biased NPN transistor

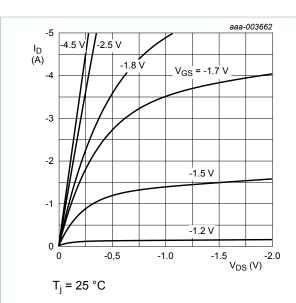
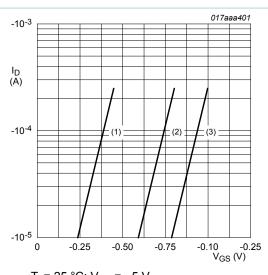


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values



$$T_i = 25 \,^{\circ}\text{C}; \, V_{DS} = -5 \,^{\circ}\text{V}$$

- (1) minimum values
- (2) typical values
- (3) maximum values

Fig. 7. Subthreshold drain current as a function of gate-source voltage

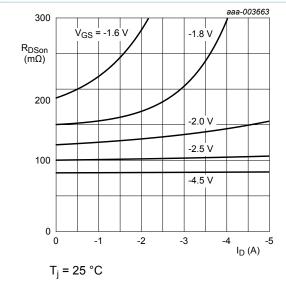


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

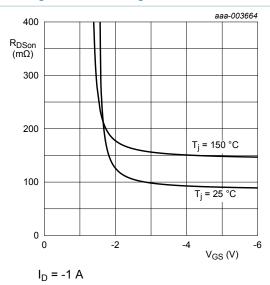
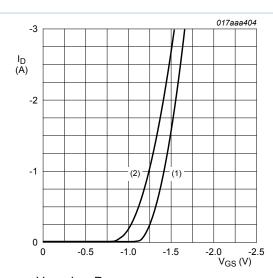


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

#### 30 V P-channel MOSFET with pre-biased NPN transistor



 $V_{DS} > I_{D} \times R_{DSon}$ 

(1)  $T_i = 25 \,^{\circ}C$ 

(2)  $T_i = 150 \, ^{\circ}C$ 

Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

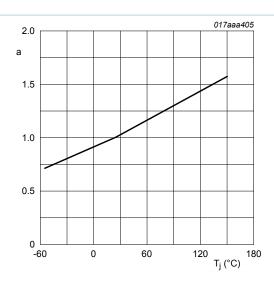
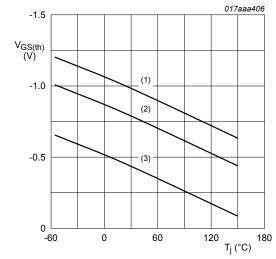


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$



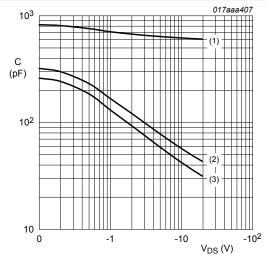
 $I_D$  = -0.25 mA;  $V_{DS}$  =  $V_{GS}$ 

(1) maximum values

(2) typical values

(3) minimum values

Fig. 12. Gate-source threshold voltage as a function of junction temperature



 $f = 1 MHz; V_{GS} = 0 V$ 

(1) C<sub>iss</sub>

(2) C<sub>oss</sub>

(3) C<sub>rss</sub>

Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

### 30 V P-channel MOSFET with pre-biased NPN transistor

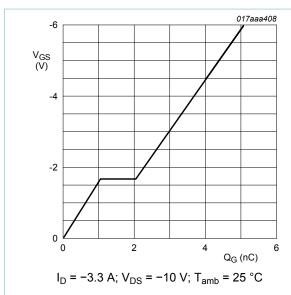


Fig. 14. Gate-source voltage as a function of gate charge; typical values

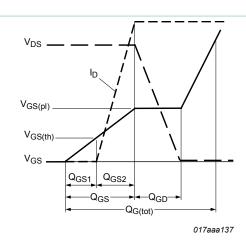
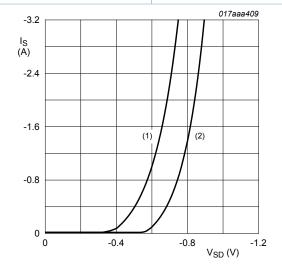


Fig. 15. Gate charge waveform definitions



 $V_{GS} = 0 V$ 

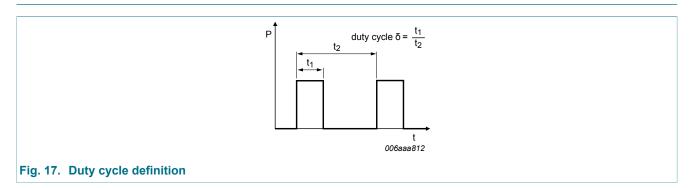
(1)  $T_{amb} = 150 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

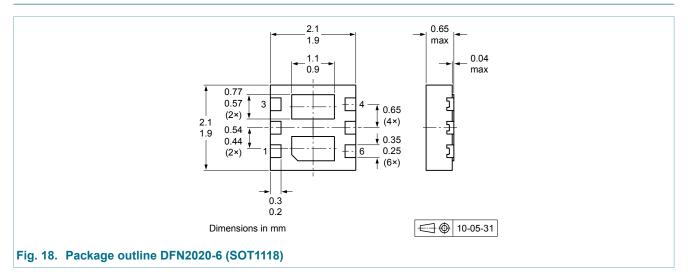
Fig. 16. Source current as a function of source-drain voltage; typical values

30 V P-channel MOSFET with pre-biased NPN transistor

## 11. Test information



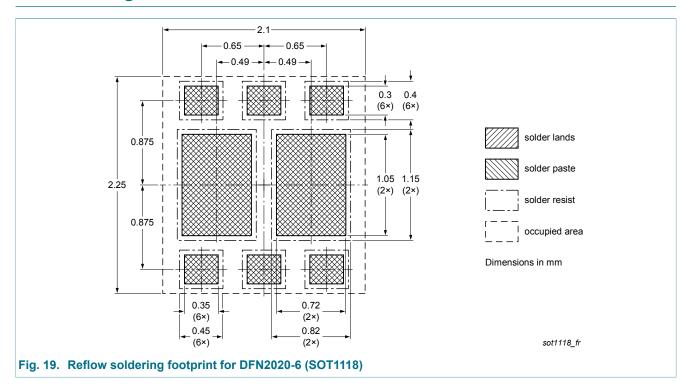
# 12. Package outline



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# 13. Soldering



# 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMC85XP v.2	20130515	Product data sheet	-	PMC85XP v.1		
Modifications:	Pinning information: graphic symbol corrected					
PMC85XP v.1	20120524	Product data sheet	-	-		

#### 30 V P-channel MOSFET with pre-biased NPN transistor

### 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 30 V P-channel MOSFET with pre-biased NPN transistor

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